2SJ399

Silicon P Channel MOS FET

Application

Low frequency power switching

Features

- Low on–resistance
- Small package
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for low signal load switch.

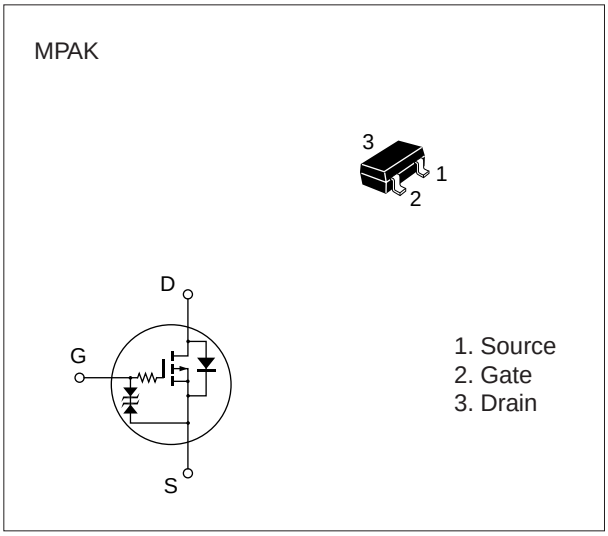


Table 1 Absolute Maximum Ratings (Ta = 25°C)

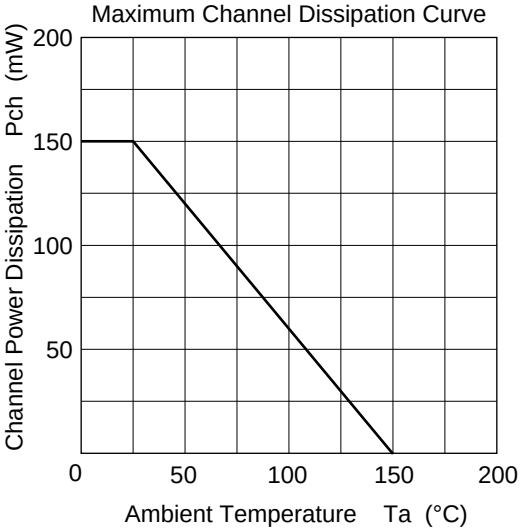
Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	–30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	–0.2	A
Drain peak current	$I_{D(pulse)}$*	–0.4	A
Body–drain diode reverse drain current	I_{DR}	–0.2	A
Channel dissipation	Pch**	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

* PW ≤ 100 µs, duty cycle ≤ 10 %
** Marking is “ZF–”

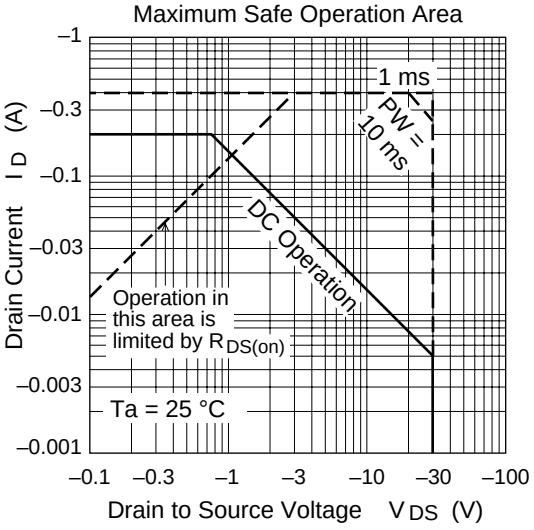
Table 2 Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	–30	—	—	V	I_D = –100 µA, V_{GS} = 0
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	I_G = ±100 µA, V_{DS} = 0
Gate to source leak current	I_{GSS}	—	—	±2	µA	V_{GS} = ±16 V, V_{DS} = 0
Zero gate voltage drain current	I_{DSS}	—	—	–1	µA	V_{DS} = –30 V, V_{GS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	–1.0	—	–2.0	V	I_D = –10 µA, V_{DS} = –5 V
Static drain to source on state resistance	$R_{DS(on)}$	—	2.7	7.5	Ω	I_D = –20 mA V_{GS} = –4 V *
		—	2.0	7	Ω	I_D = –10 mA V_{GS} = –10 V *
Input capacitance	Ciss	—	1.1	—	pF	V_{DS} = –10 V
Output capacitance	Coss	—	22.3	—	pF	V_{GS} = 0
Reverse transfer capacitance	Crss	—	0.17	—	pF	f = 1 MHz
Turn–on delay time	$t_{d(on)}$	—	530	—	ns	I_D = –0.1 A
Rise time	t_r	—	2170	—	ns	V_{GS} = –10 V
Turn–off delay time	$t_{d(off)}$	—	7640	—	ns	R_L = 100 Ω
Fall time	t_f	—	7690	—	ns	PW = 5 µs

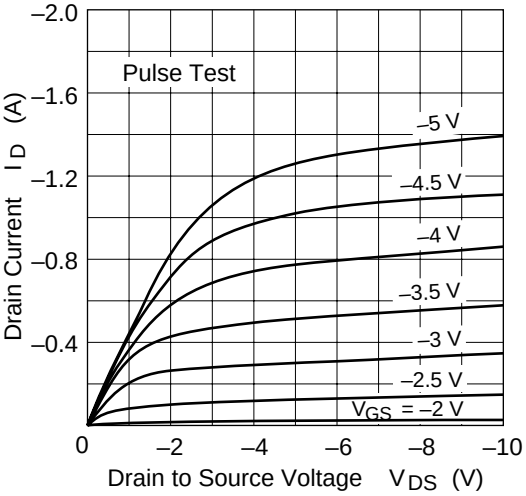
Maximum Channel Dissipation Curve



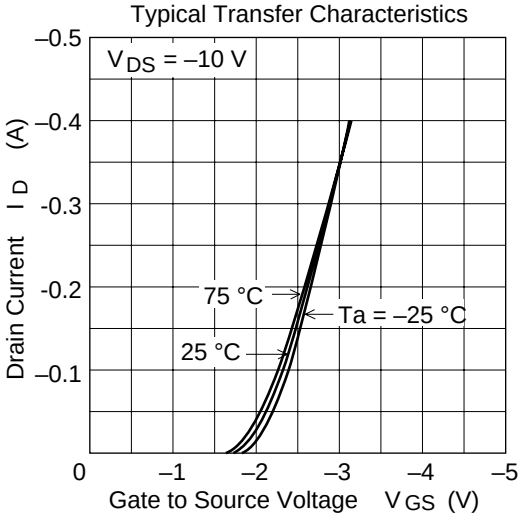
Maximum Safe Operation Area



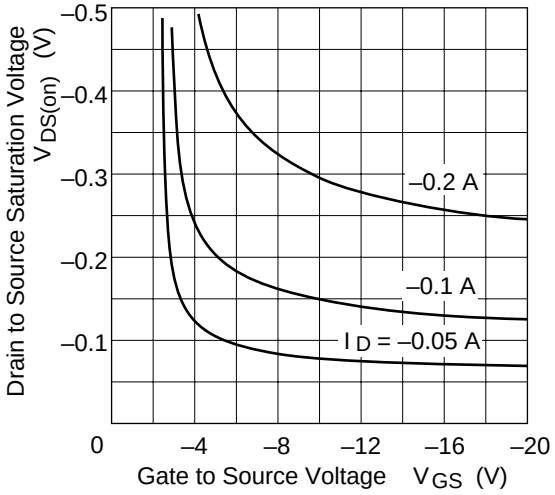
Typical Output Characteristics



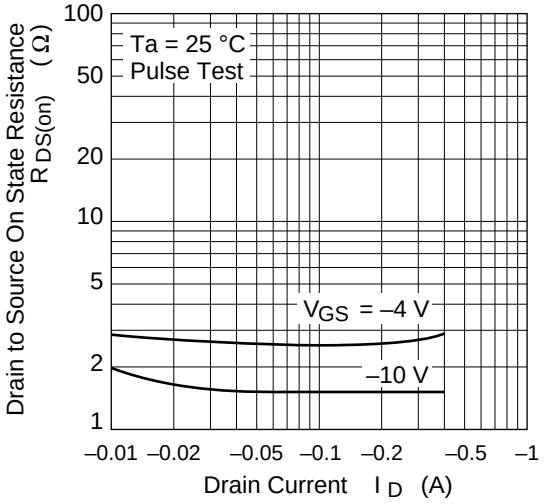
Typical Transfer Characteristics



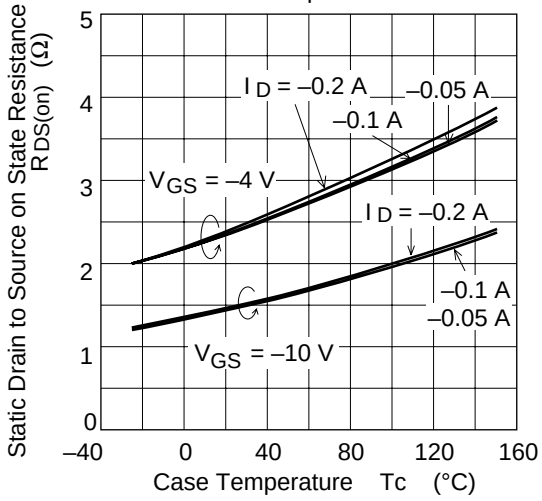
Drain to Source Saturation Voltage vs. Gate to Source Voltage



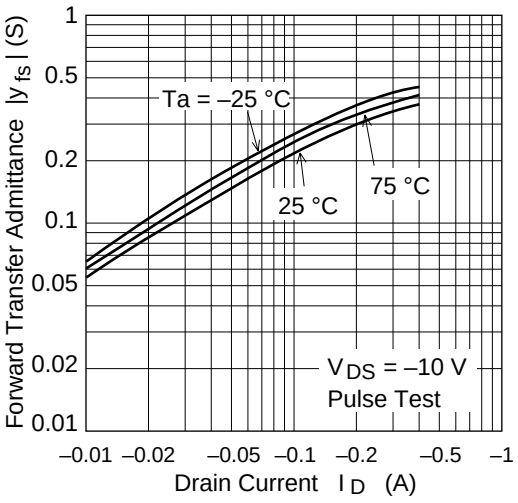
Static Drain to Source on State Resistance vs. Drain Current



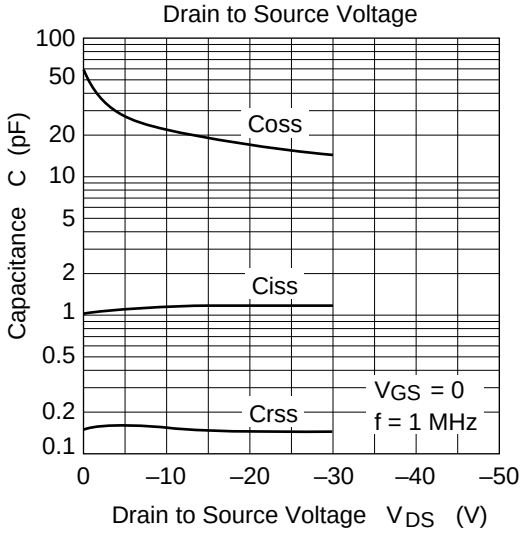
Static Drain to Source on State Resistance vs. Temperature



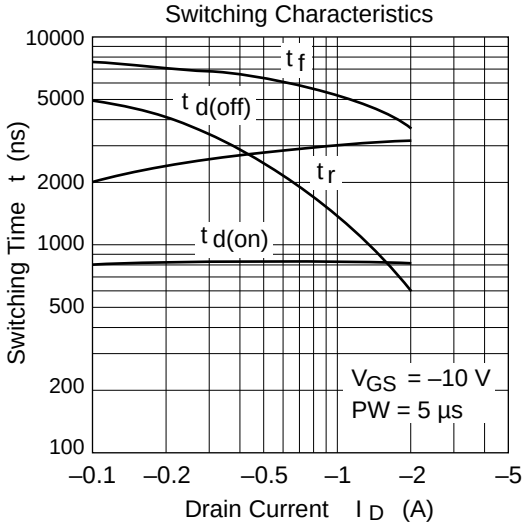
Forward Transfer Admittance vs. Drain Current



Typical Capacitance vs.
Drain to Source Voltage



Switching Characteristics



Reverse Drain Current vs.
Source to Drain Voltage